

N-Channel Logic Level Enhancement Mode Field Effect Transistor

BSS138K

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Green Compound
- ESD HBM = 2000 V as per JEDEC A114A;
 ESD CDM = 2000 V as per JEDEC C101C
- This Device is Pb-Free and is RoHS Compliant

ABSOLUTE MAXIMUM RATINGS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ (Note 1)

Symbol	Parameter	Value	Unit
V_{DSS}	Drain-Source Voltage	50	V
V _{GSS}	Gate-Source Voltage	±12	V
I _D	Drain Current – Continuous	0.22	Α
	Drain Current – Pulsed	0.88	
P_{D}	Total Device Dissipation	350	mV
	Derating above T _A = 25°C	2.8	mW/°C
T_J	Operating Junction Temperature Range	-55 to +150	°C
T _{STG}	Storage Temperature Range	-55 to +150	°C

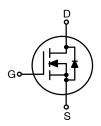
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 These ratings are limiting values above which the serviceability of any semiconductor device maybe impaired.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2)	350	٧

2. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. Minimum land pad size.





SOT-23-3 CASE 318-08

MARKING DIAGRAM



SK = Specific Device Code

M = Assembly Operation Month

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
BSS138K	SOT-23-3 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARA	CTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 10 \mu A$	50	_	-	V
$\frac{BV_{DSS}}{T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C	-	0.11	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 50 V, V _{GS} = 0 V	_	-	0.1	μΑ
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±1	μΑ
		$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±0.5	
		$V_{GS} = \pm 5 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±0.05	
ON CHARAC	TERISTICS	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.6	_	1.2	V
$\frac{V_{GS(th)}}{T_{J}}$	Gate Threshold Voltage Temperature Coefficient	I _D = 1 mA, Referenced to 25°C	-	-1.4	-	mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 1.8 V, I _D = 50 mA	-	-	2.5	Ω
		$V_{GS} = 2.5 \text{ V}, I_D = 50 \text{ mA}$		-	2.0	1
		V _{GS} = 5 V, I _D = 50 mA,	_	-	1.6	
I _{D(ON)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 5 V	0.2	-	_	Α
9FS	Forward Transconductance	V _{DS} = 10 V, I _D = 200 mA	200	_	-	mS
DYNAMIC CI	HARACTERISTICS	•				
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$	-	58	_	pF
C _{oss}	Output Capacitance	f = 1.0 MHz	_	9.75	_	
C _{rss}	Reverse Transfer Capacitance		_	5.2	-	
R_{G}	Gate Resistance	V _{DS} = 5 V, V _{GS} = 10 mV	-	281	-	Ω
SWITCHING	CHARACTERISTICS					
t _{D(ON)}	Turn-On Delay Time	V _{DD} = 30 V, I _D = 0.29 A,	_	-	5	ns
t _r	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	_	-	5	
t _{D(OFF)}	Turn-Off Delay Time		_	-	60	
t _f	Turn-Off Fall Time		-	-	35	
Qg	Total Gate Charge	V _{DS} = 25 V, I _D = 0.2 A,	-	-	2.4	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 10 \text{ V}, I_{G} = 0.1 \text{ mA}$	-	-	0.5	
Q _{gd}	Gate-Drain Charge		_	-	0.5	
ORAIN_SOLL	RCE DIODE CHARACTERISTICS AND M.	AXIMUM RATINGS				
DITAIN-000						

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

BSS138K

TYPICAL CHARACTERISTICS

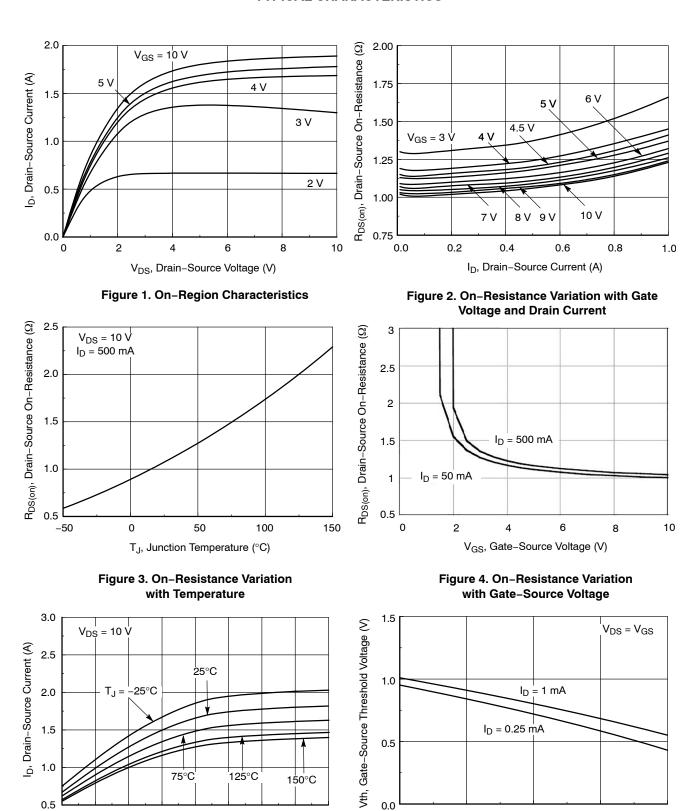


Figure 5. Transfer Characteristics

4.0

V_{GS}, Gate-Source Voltage (V)

4.5

5.0

3.5

2.0

2.5

3.0

Figure 6. Gate Threshold Variation with Temperature

50

T_J, Junction Temperature (°C)

100

150

0

-50

6.0

5.5

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TYPICAL CHARACTERISTICS (continued)

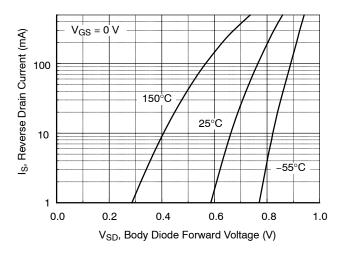


Figure 7. Reverse Drain Current Variation with Diode Forward Voltage and Temperature

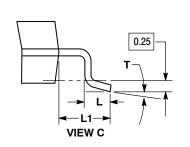


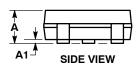
SOT-23 (TO-236) CASE 318-08 **ISSUE AS**

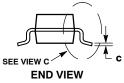
DATE 30 JAN 2018

SCALE 4:1 D - 3X b

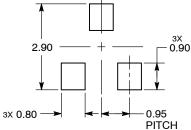
TOP VIEW







RECOMMENDED SOLDERING FOOTPRINT



DIMENSIONS: MILLIMETERS

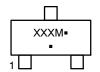
NOTES:

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
 MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH,

	PROT	RUSIONS, OR GATE BURRS.	
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	MILLIMETERS				INCHES	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.039	0.044
A1	0.01	0.06	0.10	0.000	0.002	0.004
b	0.37	0.44	0.50	0.015	0.017	0.020
С	0.08	0.14	0.20	0.003	0.006	0.008
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.080
L	0.30	0.43	0.55	0.012	0.017	0.022
L1	0.35	0.54	0.69	0.014	0.021	0.027
HE	2.10	2.40	2.64	0.083	0.094	0.104
T	0°		10°	0°		10°

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE
OT (1 F O			

SOT-23 (TO-236)

STYLE 9:	STYLE 10:	STYLE 11:	STYLE 12:	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. SOURCE	PIN 1. CATHODE
ANODE	SOURCE	CATHODE	CATHODE	2. DRAIN	2. GATE
CATHODE	3. GATE	CATHODE-ANODE	ANODE	3. GATE	ANODE

STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:	STYLE 19:	STYLE 20:
PIN 1. GATE	PIN 1. ANODE	PIN 1. NO CONNECTION	PIN 1. NO CONNECTION	PIN 1. CATHODE	PIN 1. CATHODE
CATHODE	CATHODE	2. ANODE	CATHODE	2. ANODE	ANODE
ANODE	CATHODE	CATHODE	ANODE	CATHODE-ANOD	E 3. GATE

STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:	STYLE 25:	STYLE 26:
PIN 1. GATE	PIN 1. RETURN	PIN 1. ANODE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE
SOURCE	OUTPUT	2. ANODE	2. DRAIN	2. CATHODE	2. ANODE
3 DRAIN	3 INPLIT	3 CATHODE	3. SOURCE	3. GATE	NO CONNECTION

STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE	
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